

 <small>ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®</small>		<b>Material Composition Declaration</b> <small>© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.</small>		<small>This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.</small> <b>Adobe Reader version 7.0.5 is required to complete this declaration.</b>							
IPC-1752-2 v1.02		IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>			Form Type *		Declaration Class *				
<b>Supplier Information</b>											
Company Name *		Company Unique ID		Unique ID Authority		Response Date *		Response Document ID			
Contact Name *		Title - Contact		Phone - Contact *		Email - Contact *					
Authorized Representative *		Title - Representative		Phone - Representative *		Email - Representative *		Supplier Comments or URL for Additional Information			
	Requester Item Number	Mfr Item Number	Mfr Item Name		Effective Date	Version	Manufacturing Site		Weight	UOM	Unit Type
	Alternate Recommendation					Alternate Item Comments					
<b>Manufacturing Process Information</b>											
Terminal Plating / Grid Array Material			Terminal Base Alloy		J-STD-020 MSL Rating		Peak Process Body Temperature		Max Time at Peak Temperature		Number of Reflow Cycles
							C		seconds		
Comments											

Save the fields in this form to a file		Import fields from a file into this form		Locked	
RoHS Material Composition Declaration				Declaration Type * <input type="text"/>	
<b>RoHS Definition:</b> Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium					
RoHS Declaration *			Supplier Acceptance		
<b>Exemptions:</b> If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and checkboxes will appear below. Check all applicable exemptions.					
1. Mercury in compact fluorescent lamps not exceeding 5 mg per lamp.  2a. Mercury in straight fluorescent lamps for general purposes not exceeding 10 mg in halophosphate lamps  2b. Mercury in straight fluorescent lamps for general purposes not exceeding 5 mg in triphosphate lamps with a normal lifetime  2c. Mercury in straight fluorescent lamps for general purposes not exceeding 8 mg in triphosphate lamps with long lifetime  3. Mercury in straight fluorescent lamps for special purposes.  4. Mercury in other lamps not specifically mentioned in this list.  5. Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.  6a. Lead as an alloying element in steel containing up to 0.35% lead by weight.  6b. Lead as an alloying element in aluminum containing up to 0.4% lead by weight.  6c. Lead as an alloying element in copper containing up to 4% lead by weight.  7a. Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).  7b. Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission as well as network management for telecommunications.			7c. Lead in electronic ceramic parts (e.g. piezoelectronic devices).  8. Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/338/EEC amending Directive 76/769/EEC relating to restrictions on the marketing and use of certain dangerous substances and preparations piezoelectronic devices).  9. Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators  10a. Deca BDE in polymeric applications  10b. Lead in lead-bronze bearing shells  11. Lead used in compliant pin connector systems.  12. Lead as a coating material for a thermal conduction module c-ring.  13a. Lead in optical and filter glass.  13b. Cadmium in optical and filter glass.  14. Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight .  15. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages.		
Declaration Signature					
<b>Instructions:</b> Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.					
Supplier Digital Signature					

## Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +P Inserts a New Part    +M Inserts a new Material    +C Inserts a new Substance Category    +S Inserts a new Substance    - Deletes the element line

[illegible]

[illegible]